

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("6809000").PN.	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:12
L2	0	1 and polysilicon	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:12
L3	0	1 and polysi	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:12
L4	0	1 and poly	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:12
L5	0	1 and polycrystalline	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:16
L6	0	1 and thick\$^	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:17
L7	1	1 and thick\$6	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:30
L8	1134	TiN near2 cvd	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:31
L9	28	(TiN near2 cvd) with (advantag\$6 benefit\$3)	US-PGPUB; USPAT	OR	OFF	2004/11/14 15:32
S1	6672	((438/240) or (438/3) or (438/239-242) or (438/250-256) or (438/393-399)).CCLS.	US-PGPUB; USPAT	OR	OFF	2004/11/13 23:24
S2	6426	S1 not (@ad>"20030709" or @rlad>"20030709")	US-PGPUB; USPAT	OR	ON	2004/11/13 23:24
S3	386	S2 and ((upper top) near2 (electrode plate node)) with (polysilicon poly polysi polycrystalline) with (metal ti w tin titanium tungsten aluminum al)	US-PGPUB; USPAT	OR	ON	2004/11/13 18:45
S4	0	("2004/0115881").URPN.	USPAT	OR	OFF	2004/11/13 21:17
S5	256	(jennifer near2 kennedy).xa.	USPAT	OR	OFF	2004/11/13 22:56
S6	1	("6083785").PN.	US-PGPUB; USPAT	OR	OFF	2004/11/13 23:14
S7	1	("6800889").PN.	US-PGPUB; USPAT	OR	OFF	2004/11/13 23:14
S8	1	S7 and TiN	US-PGPUB; USPAT	OR	OFF	2004/11/13 23:14
S9	1	S7 and "65"	US-PGPUB; USPAT	OR	OFF	2004/11/13 23:14
S10	6672	((438/240) or (438/3) or (438/239-242) or (438/250-256) or (438/393-399)).CCLS.	US-PGPUB; USPAT	OR	OFF	2004/11/13 23:24
S11	6426	S10 not (@ad>"20030709" or @rlad>"20030709")	US-PGPUB; USPAT	OR	ON	2004/11/14 01:38

S12	150	S11 and ((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 00:43
S13	20	S11 and ((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with (cap capping) with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 01:17
S14	165	S12 or S13	US-PGPUB; USPAT	OR	ON	2004/11/13 23:36
S15	0	tin/polysilicon/tin	US-PGPUB; USPAT	OR	ON	2004/11/13 23:46
S16	0	tin/polysi/tin	US-PGPUB; USPAT	OR	ON	2004/11/13 23:46
S17	0	tin/poly/tin	US-PGPUB; USPAT	OR	ON	2004/11/13 23:46
S18	1	tin adj polysilicon adj tin	US-PGPUB; USPAT	OR	ON	2004/11/13 23:47
S19	0	tin adj polysi adj tin	US-PGPUB; USPAT	OR	ON	2004/11/13 23:47
S20	0	tin adj poly adj tin	US-PGPUB; USPAT	OR	ON	2004/11/13 23:47
S21	8	S11 and ((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with (arc) with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 00:12
S22	7	S21 not S13	US-PGPUB; USPAT	OR	ON	2004/11/14 00:08
S23	0	S11 and ((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with (antireflective) with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 00:12
S24	2	S11 and ((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with (anti adj reflective) with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 00:35
S25	1	("6756282").PN.	US-PGPUB; USPAT	OR	OFF	2004/11/14 00:35
S26	1	S25 and "22"	US-PGPUB; USPAT	OR	OFF	2004/11/14 00:35
S27	1320	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 00:43

S28	268	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with (cap capping) with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 01:08
S29	111	S28 and ("438"/\$.ccls. or "257"/\$.ccls.)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:18
S30	697	S27 and ("438"/\$.ccls. or "257"/\$.ccls.)	US-PGPUB; USPAT	OR	ON	2004/11/14 00:44
S31	52	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) adj over) with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 01:11
S32	62	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over with top with sides) with (upper top) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 01:16
S33	57	S32 not (@ad>"20030709" or @rlad>"20030709")	US-PGPUB; USPAT	OR	ON	2004/11/14 01:16
S34	273	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over) with (upper top) with (electrode plate node))	EPO; JPO; DERWENT	OR	ON	2004/11/14 01:31
S35	406	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over) with (upper top second) with (electrode plate node))	EPO; JPO; DERWENT	OR	ON	2004/11/14 01:31
S36	29	S11 and ((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with (cap capping) with (upper top second) with (electrode plate node))	US-PGPUB; USPAT	OR	ON	2004/11/14 01:17
S37	9	S36 not S13	US-PGPUB; USPAT	OR	ON	2004/11/14 01:17
S38	0	S35 and ("438"/\$.ccls. or "257"/\$.ccls.)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:19
S39	0	S35 and (capacitor dram)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:19
S40	0	S35 and (substrate semiconductor)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:19
S41	65	S35 and (capacitor dram)	EPO; JPO; DERWENT	OR	ON	2004/11/14 01:20
S42	39	S35 and ("438"/\$.ccls. or "257"/\$.ccls.)	EPO; JPO; DERWENT	OR	ON	2004/11/14 01:22
S43	103	S41 or S42	EPO; JPO; DERWENT	OR	ON	2004/11/14 01:20
S44	64	S41 not S42	EPO; JPO; DERWENT	OR	ON	2004/11/14 01:27

S45	1	("6500658").PN.	US-PGPUB; USPAT	OR	OFF	2004/11/14 01:28
S46	1	("6500678").PN.	US-PGPUB; USPAT	OR	OFF	2004/11/14 01:28
S47	1	S46 and "118"	US-PGPUB; USPAT	OR	OFF	2004/11/14 01:28
S48	2	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over) with (upper second top) with (electrode plate node)) with (etch\$3 adj stop\$3)	EPO; JPO; DERWENT	OR	ON	2004/11/14 01:32
S49	17	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over) with (upper second top) with (electrode plate node)) with (etch\$3 adj stop\$3)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:34
S50	8	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over) with (upper second top) with (electrode plate node)) with (diffusion adj barrier)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:37
S51	100	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over) with (upper second top) with (electrode plate node)) with (barrier)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:44
S52	92	S51 not S50	US-PGPUB; USPAT	OR	ON	2004/11/14 01:38
S53	86	S52 not (@ad>"20030709" or @rlad>"20030709")	US-PGPUB; USPAT	OR	ON	2004/11/14 01:44
S54	57	((titanium (titanium adj nitride) w tungsten aluminum al ti tin) with over) with (upper second top) with (electrode plate node)) with (resistance)	US-PGPUB; USPAT	OR	ON	2004/11/14 01:44
S55	54	S54 not (@ad>"20030709" or @rlad>"20030709")	US-PGPUB; USPAT	OR	ON	2004/11/14 01:44